



# BRT30N100P3

## N-channel Enhancement Mode Power MOSFET

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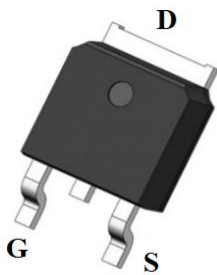
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## FEATURES

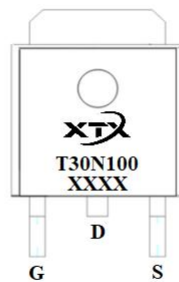
- ◆ 30V, 100A
- ◆  $R_{DS(ON)} < 3.6m\Omega @ V_{GS} = 10V$
- ◆  $R_{DS(ON)} < 6.1m\Omega @ V_{GS} = 4.5V$
- ◆ Advanced Trench Technology
- ◆ Excellent  $R_{DS(ON)}$  and Low Gate Charge
- ◆ Lead Free

## APPLICATIONS

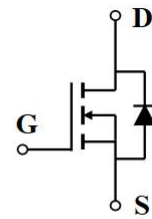
- ◆ Load Switch
- ◆ PWM Application
- ◆ Power Management



TO-252-2L Top View



Marking and Pin Assignment



Schematic Diagram

## PACKAGE MARKING AND ORDERING INFORMATION

OPN	Marking	Package	Quantity
BRT30N100P3	T30N100	TO-252-2L	2500pcs/Reel

## ABSOLUTE MAXIMUM RATINGS

Symbol	Definition	Ratings	Unit	
$V_{DS}$	Drain-to-Source Voltage	30	V	
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V	
$I_D$	Continuous Drain Current	$T_C = 25^\circ C$	100	A
		$T_C = 100^\circ C$	63	A
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>	400	A	
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(2)</sup>	156	mJ	
$P_D$	Power Dissipation, $T_C = 25^\circ C$	80	W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(3)</sup>	32	$^\circ C/W$	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.6	$^\circ C/W$	
$T_J, T_{STG}$	Junction & Storage Temperature Range	-55 ~ +150	$^\circ C$	

**ELECTRICAL CHARACTERISTICS** (All test condition is  $T_J=25^{\circ}\text{C}$ , unless otherwise noted)

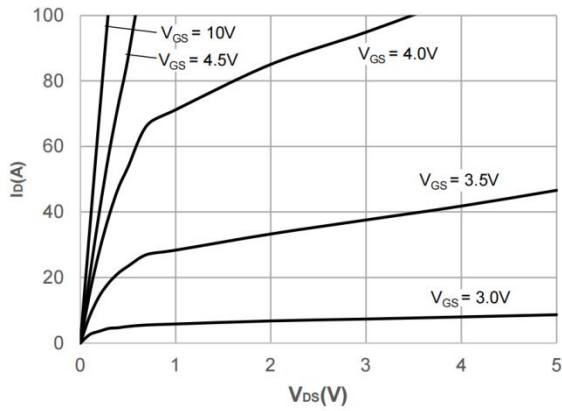
Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	30	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 30\text{V}, V_{GS} = 0\text{V}$	-	-	1	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.1	1.6	2.5	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance <sup>(4)</sup>	$V_{GS} = 10\text{V}, I_D = 30\text{A}$		2.6	3.6	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 20\text{A}$		3.7	6.1	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 15\text{V}, f = 1\text{MHz}$	-	2789	-	pF
$C_{oss}$	Output Capacitance		-	365	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	309	-	pF
$R_G$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1.0\text{MHz}$	-	2.34	-	$\Omega$
$Q_g$	Total Gate Charge	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 15\text{V}, I_D = 30\text{A}$	-	58	-	nC
$Q_{gs}$	Gate Source Charge		-	12	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge		-	13	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{GS} = 10\text{V}, V_{DD} = 15\text{V}$ $I_D = 30\text{A}, R_G = 3\Omega$	-	11	-	ns
$t_r$	Turn-On Rise Time		-	29	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	47	-	ns
$t_f$	Turn-Off Fall Time		-	18	-	ns
<b>Drain-Source Diode Characteristics</b>						
$I_S$	Continuous Source Current		-	-	100	A
$V_{SD}$	Forward on voltage	$V_{GS} = 0\text{V}, I_S = 30\text{A}$	-	-	1.2	V
$T_{rr}$	Reverse Recovery Time	$I_F = 30\text{A}, di/dt = 100\text{A}/\mu\text{s}$	-	16	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	7	-	nC

Notes:

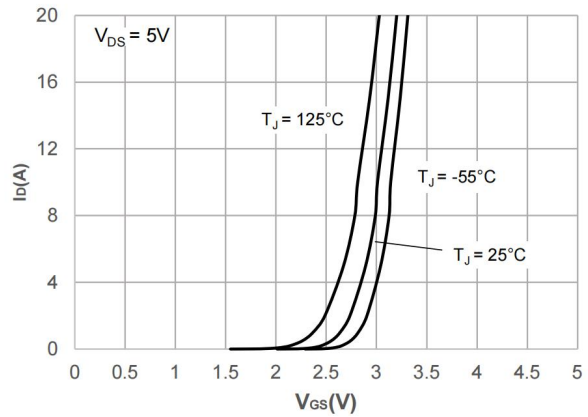
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
2.  $E_{AS}$  condition: Starting  $T_J=25^{\circ}\text{C}$ ,  $V_{DD}=15\text{V}$ ,  $V_G=10\text{V}$ ,  $R_G=25\Omega$ ,  $L=0.5\text{mH}$ ,  $I_{AS}=25\text{A}$
3.  $R_{\theta JA}$  is measured with the device mounted on a 1 inch<sup>2</sup> pad of 2oz copper FR4 PCB
4. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

**TYPICAL PERFORMANCE CHARACTERISTICS**

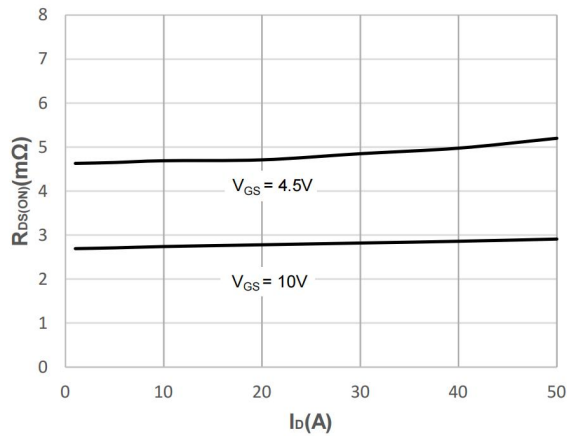
**Figure 1: Output Characteristics**



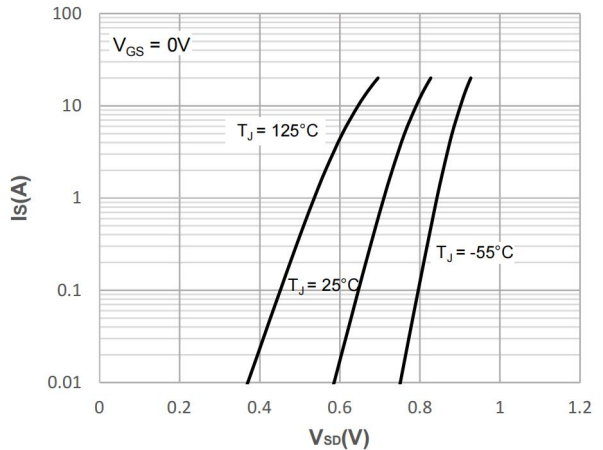
**Figure 2: Typical Transfer Characteristics**



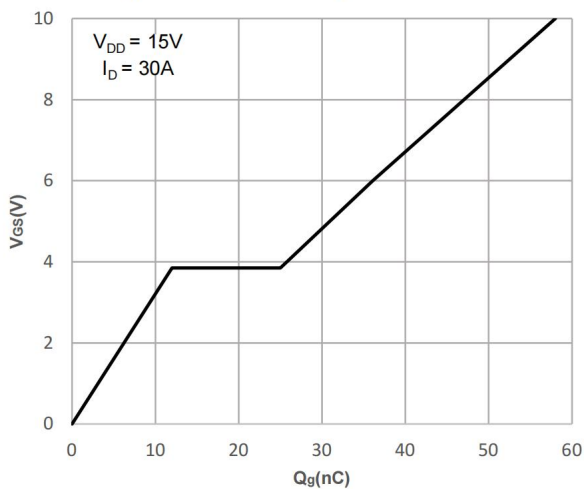
**Figure 3: On-resistance vs. Drain Current**



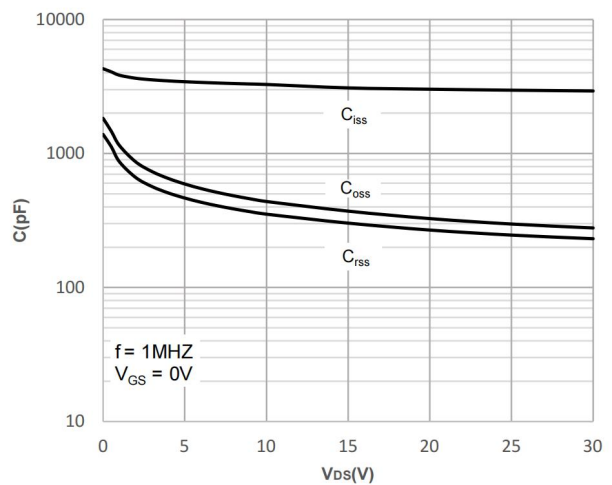
**Figure 4: Body Diode Characteristics**



**Figure 5: Gate Charge Characteristics**

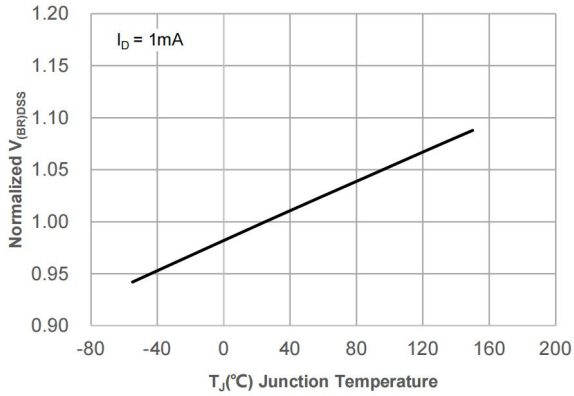


**Figure 6: Capacitance Characteristics**

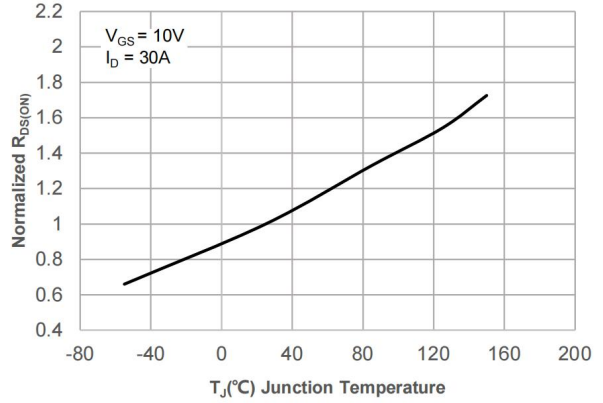


**TYPICAL PERFORMANCE CHARACTERISTICS**

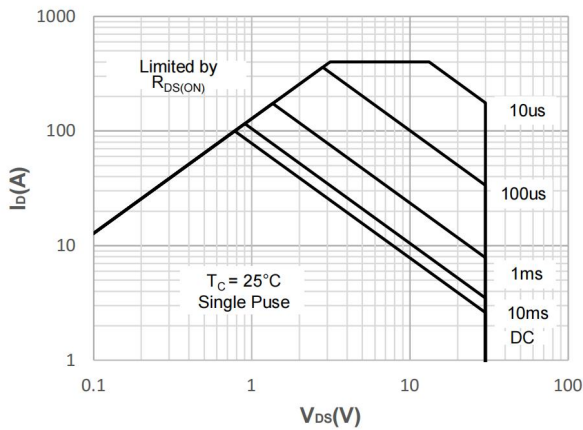
**Figure 7: Normalized Breakdown voltage vs. Junction Temperature**



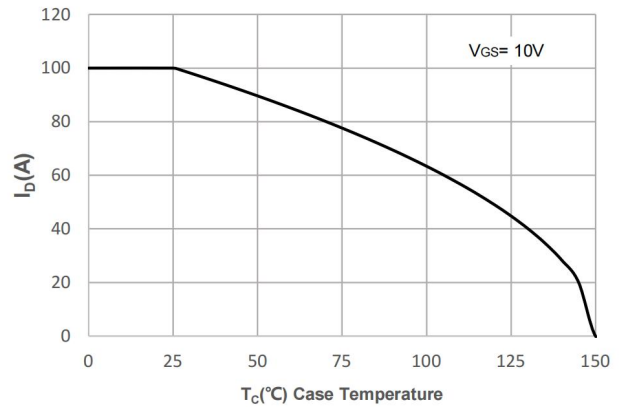
**Figure 8: Normalized on Resistance vs. Junction Temperature**



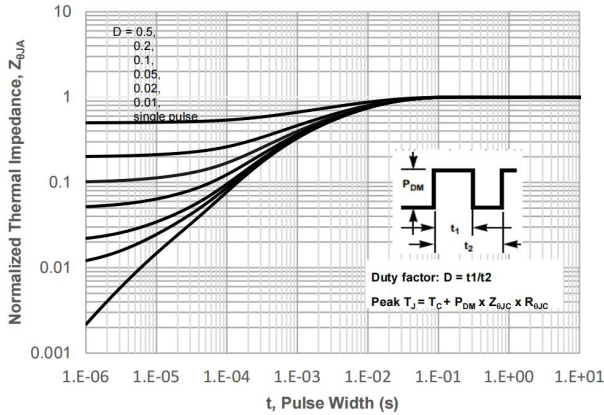
**Figure 9: Maximum Safe Operating Area**



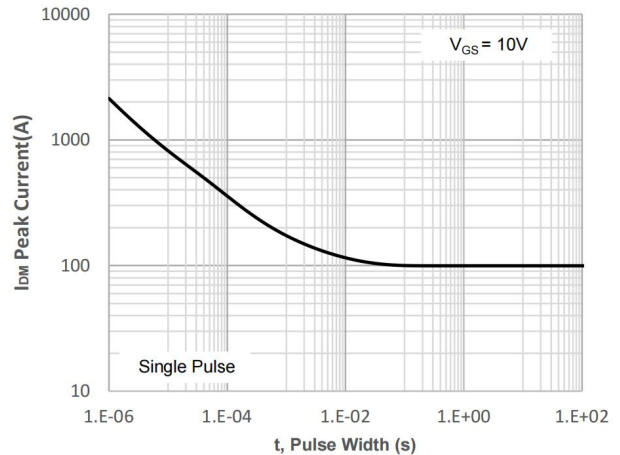
**Figure 10: Maximum Continuous Drain Current vs. Case Temperature**



**Figure 11: Normalized Maximum Transient Thermal Impedance**



**Figure 12: Peak Current Capacity**



TEST CIRCUIT

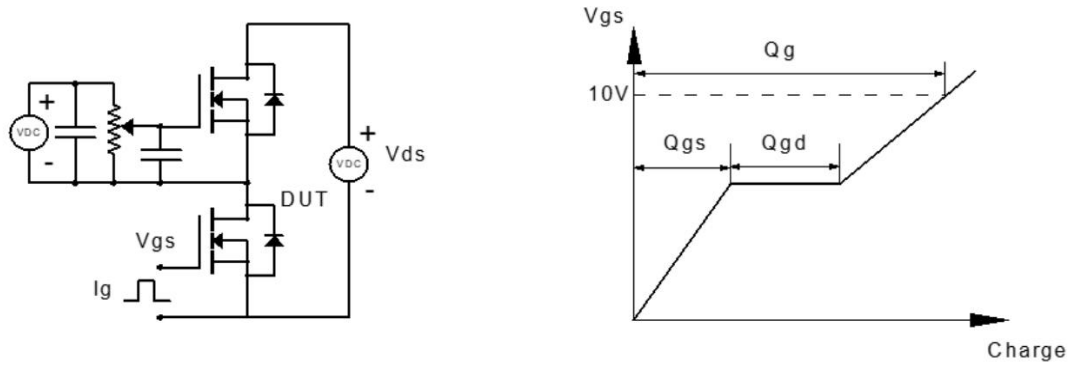


Figure 13: Gate Charge Test Circuit & Waveform

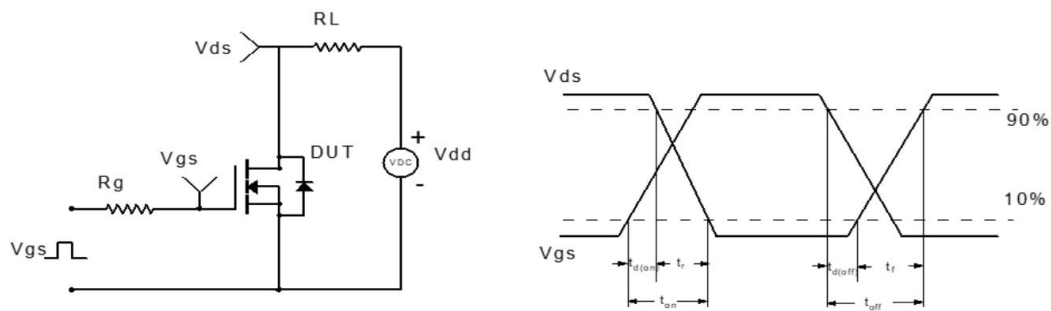


Figure 14: Resistive Switching Test Circuit & Waveform

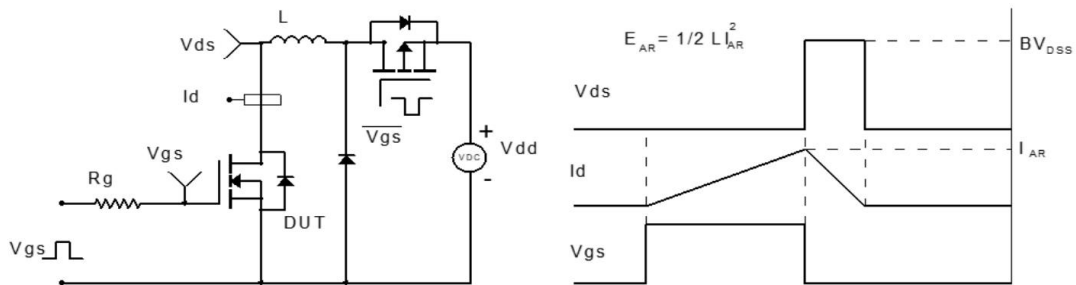


Figure 15: Unclamped Inductive Switching Test Circuit & Waveform

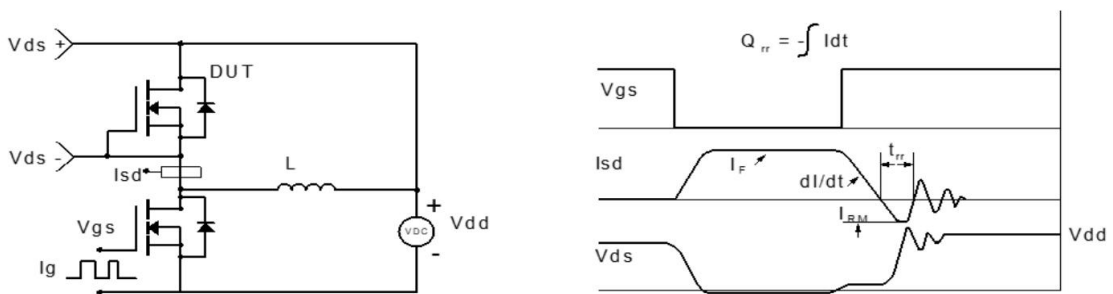
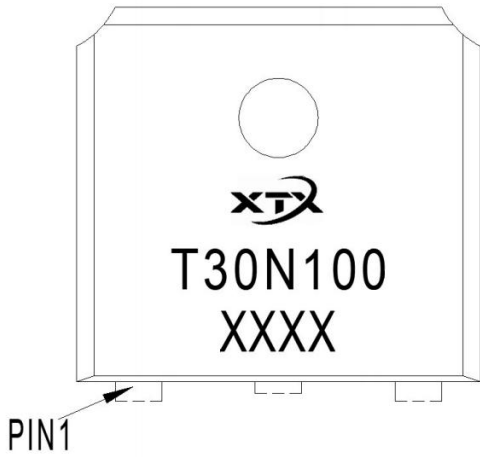


Figure 16: Diode Recovery Test Circuit & Waveform

**MARKING INFORMATION**



1st Line: XTX Logo

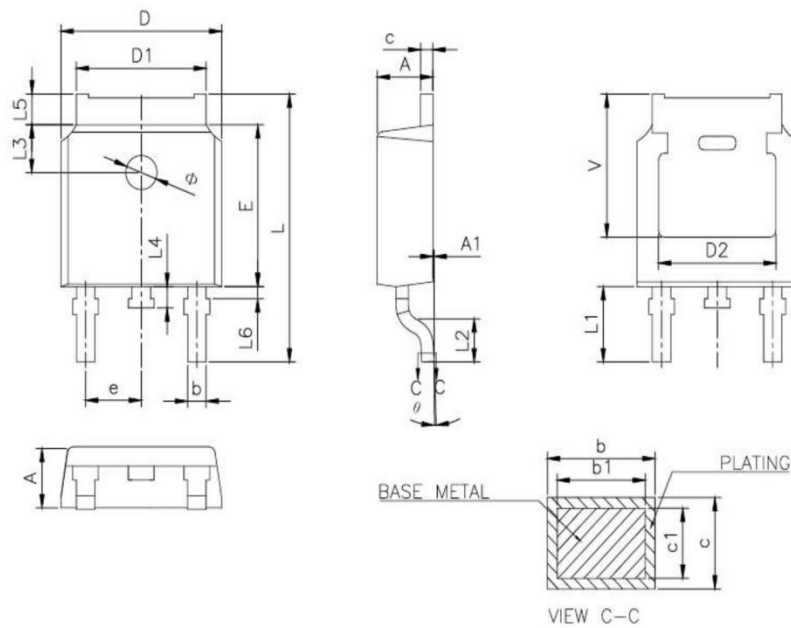
2nd Line: Part Number (T30N100)

3rd Line: Date Code (XXXX)

XX: Year

XX: Week (01 to 53)

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	21	22	23	24	25	26	27	28	29	30	31	32	33

**DETAIL PACKAGE OUTLINE DRAWING (TO-252-2L)**


SYMBOL	MILLIMETERS		
	MIN	NOM	MAX
A	2.20	2.30	2.40
A1	0.00	-	0.10
b	0.66	-	0.86
b1	0.65	0.76	0.81
c	0.47	-	0.60
c1	0.46	0.51	0.56
D	6.50	6.60	6.70
D1	5.10	5.33	5.46
D2	4.83 REF.		
E	6.00	6.10	6.20
e	2.186	2.286	2.386
L	9.80	10.10	10.40
L1	2.90 REF.		
L2	1.40	1.50	1.60
L3	1.80 REF.		
L4	0.60	0.80	1.00
L5	0.90	-	1.25
L6	0.15	-	0.75
Φ	1.10	-	1.30
θ	0		8°
V	5.40 REF.		



**REVISION HISTORY**

<b>Number</b>	<b>Description</b>
Rev 1.0	BRT30N100P3 datasheet release